



AGH UNIVERSITY OF SCIENCE  
AND TECHNOLOGY

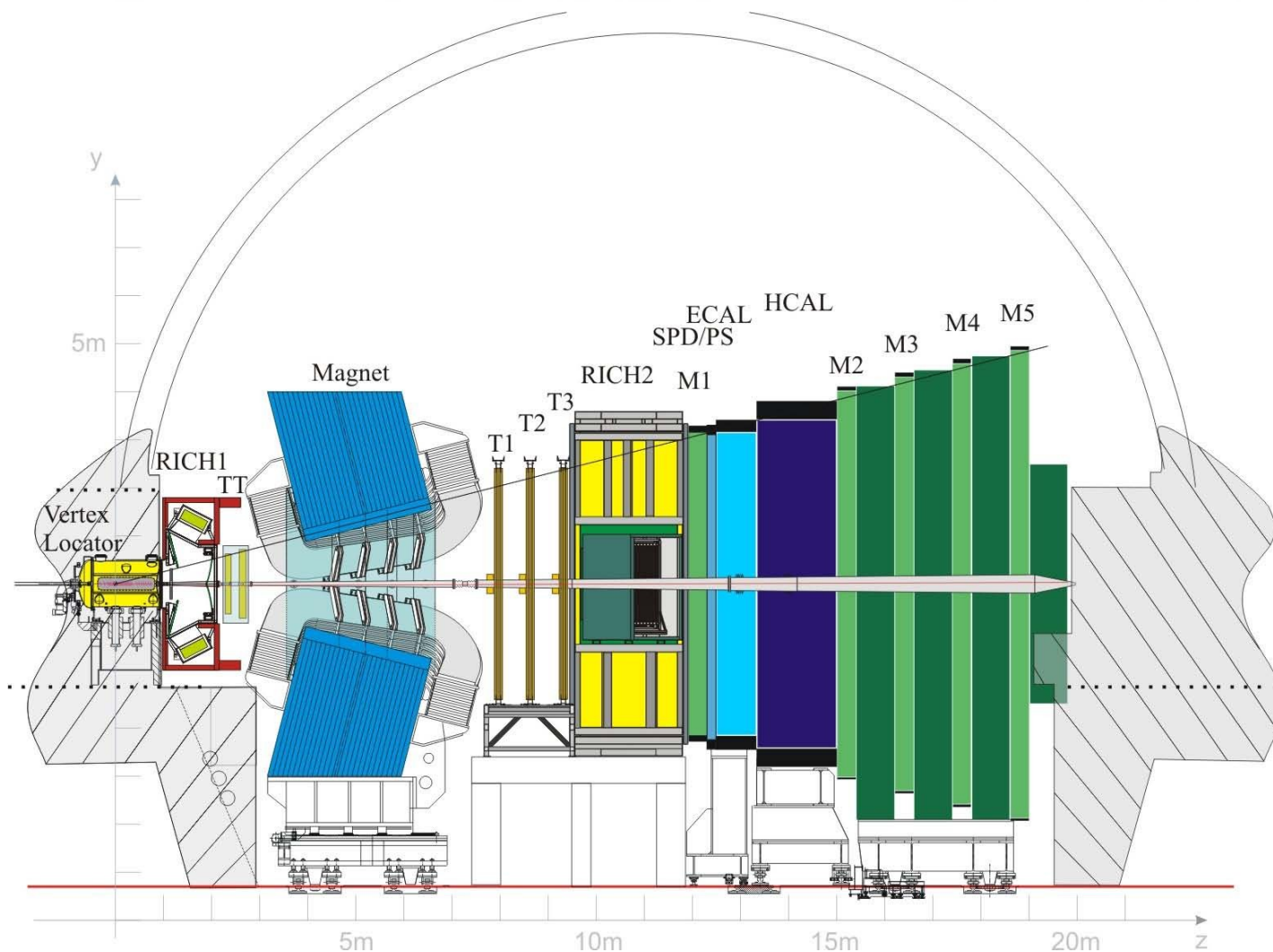


# Recent results on radiation damage in the LHCb silicon tracking system

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**on behalf of VELO & Silicon Tracker**

20th RD50 Workshop (Bari, Italy) 30th of May 2012

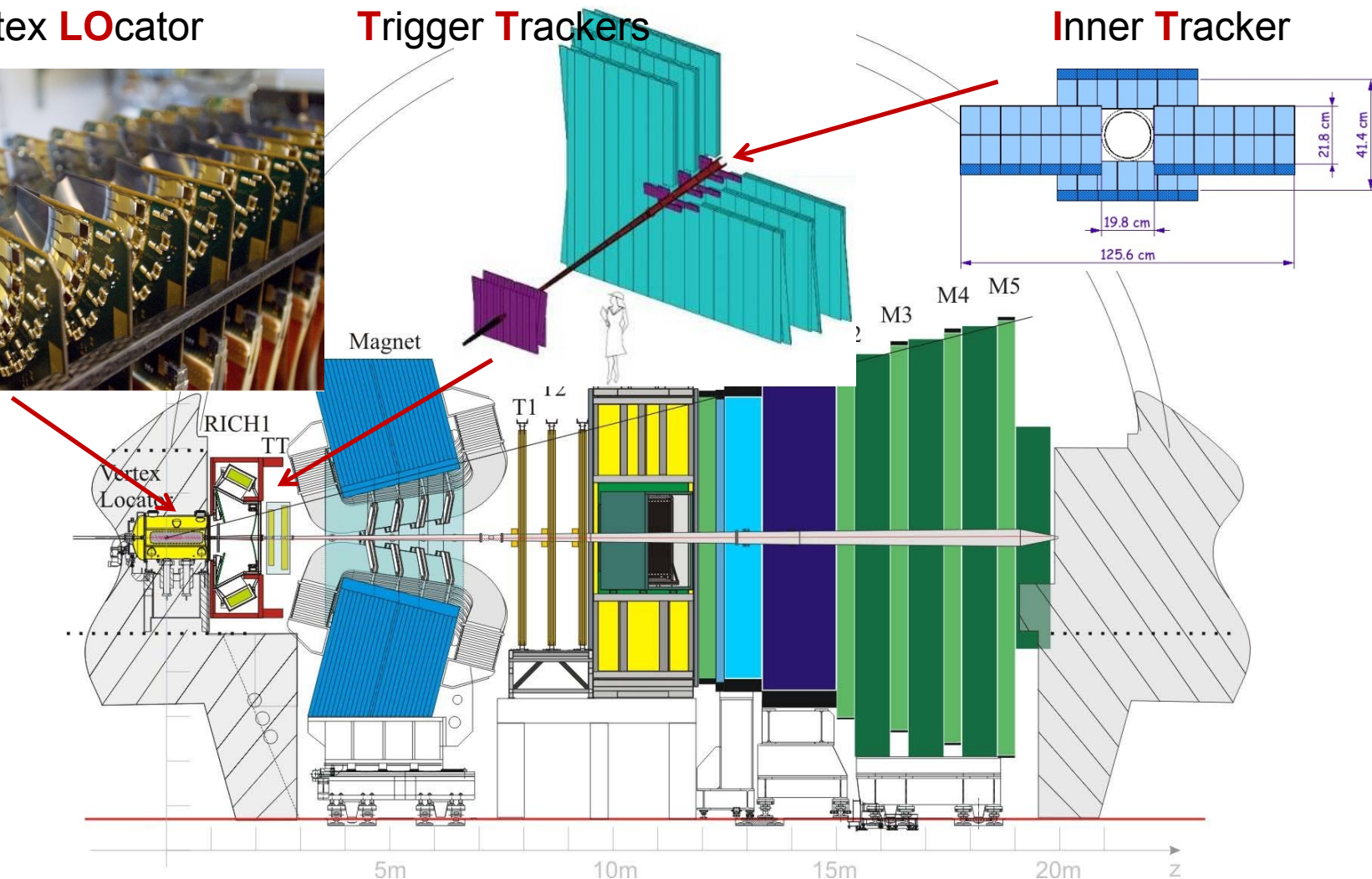
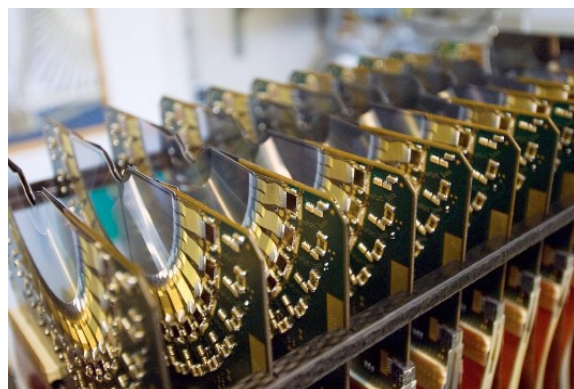


# LHCb spectrometer- silicon tracking systems

**VER**tex **LO**cator

**T**riger **T**rackers

**I**nnner **T**racker

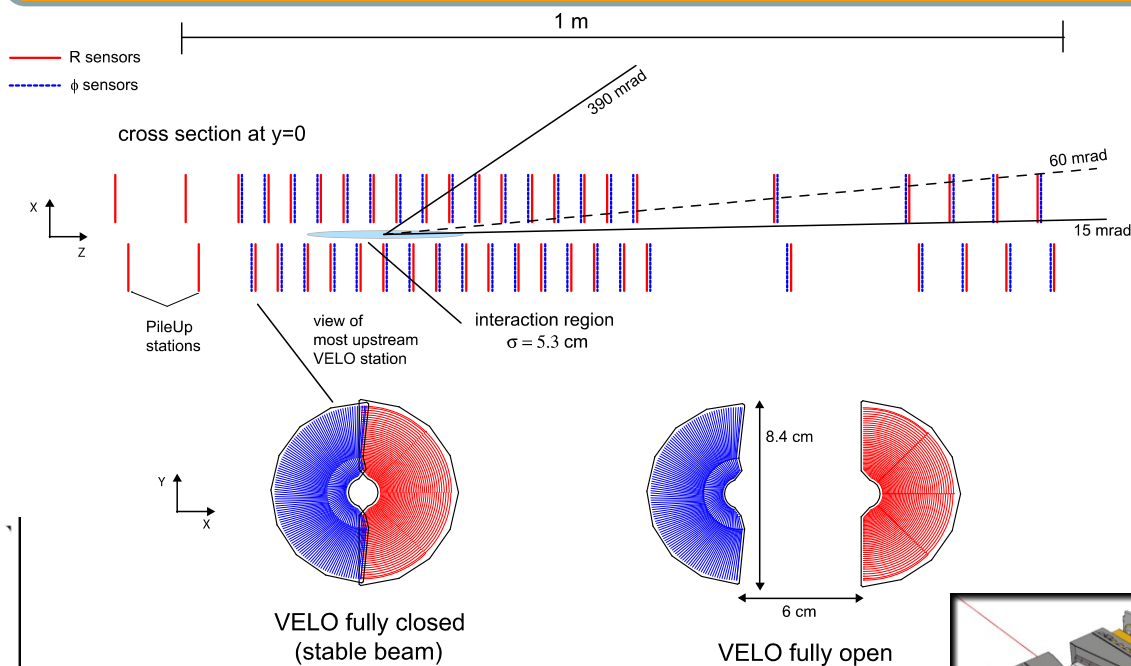




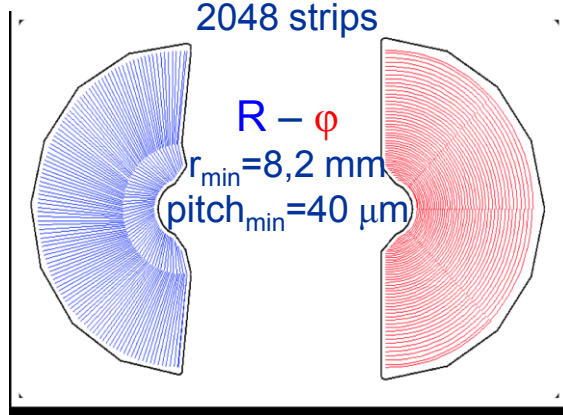
**VELO**



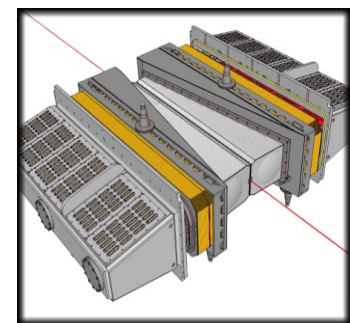
**Mobile:** opening every fill and centering on the beam with self measured vertices



**88 silicon sensors**  
 300  $\mu\text{m}$ ,  $n^+n$  and  $n$  on  $p$   
 double metal layer  
 2048 strips



**Cooled:** by evaporative  $\text{CO}_2$  system,  
 operating in vacuum







# VELO goals



## Tracking:

- ▶ high precision measurement of trajectories close to the interaction point

## Vertexing:

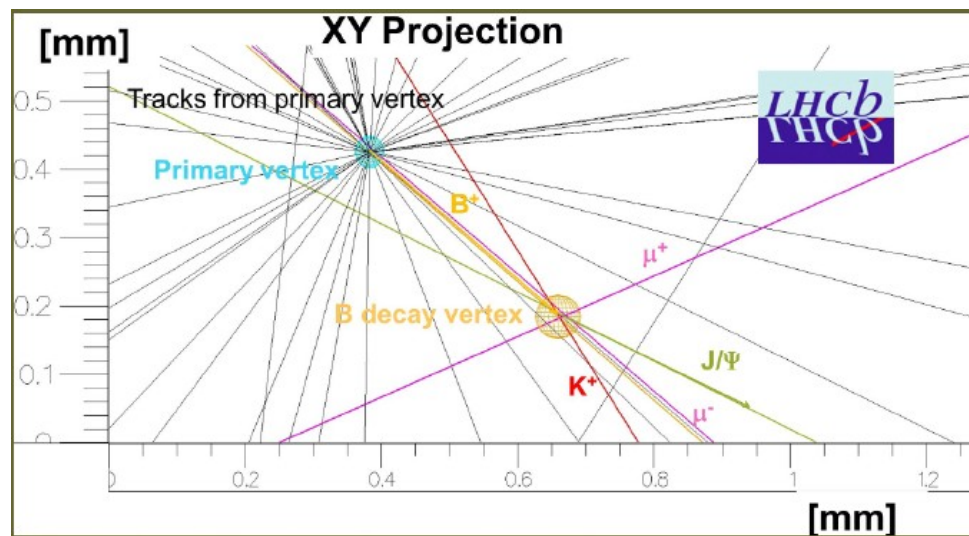
- ▶ production and decay vertices of b and c hadrons,
- ▶ accurate measurement of decay lifetimes

## Tagging:

- ▶ impact parameters

## Trigger:

- ▶ VELO's input is absolutely vital for physics, HLT (high level trigger) relies on all listed quantities



- ▶ Hit resolution  $4\mu\text{m}$
- ▶ momentum resolution  $\Delta p/p = 0.4\% - 0.55\%$
- ▶ PV resolution  $13\mu\text{m}$
- ▶ IP resolution  $13\mu\text{m}$  for high
- ▶ transverse momentum tracks

Proper time resolution  $\sim 50\text{ fs}$

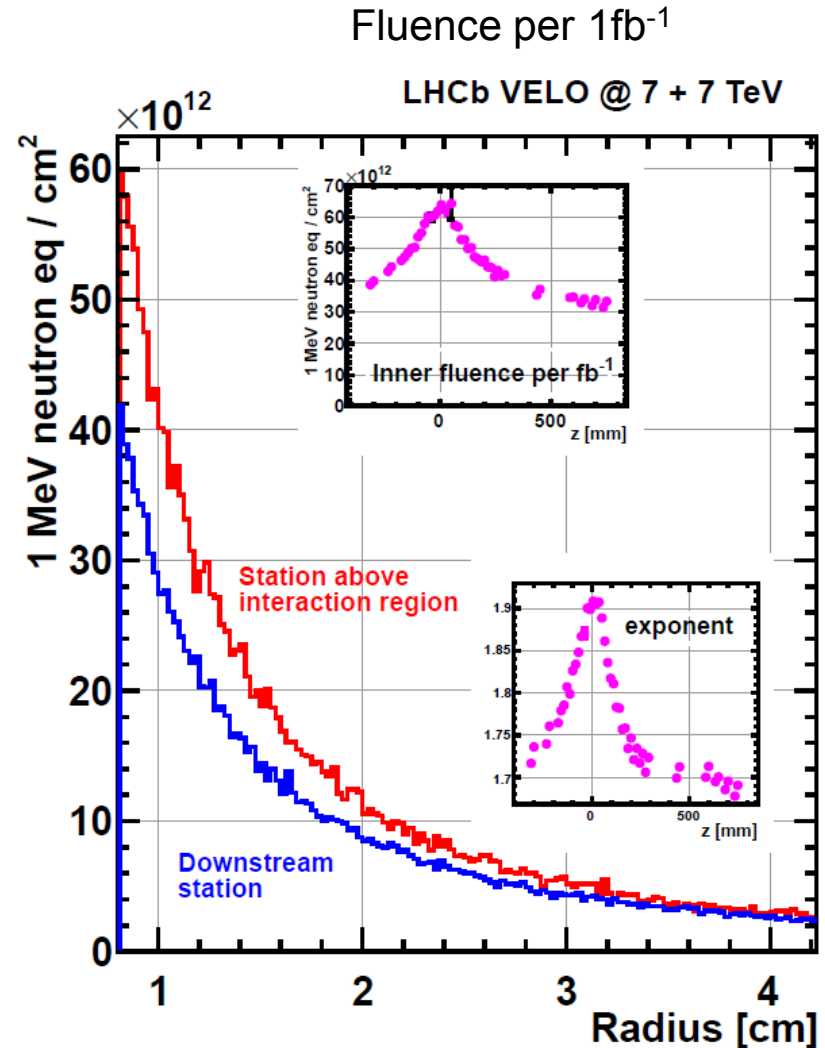
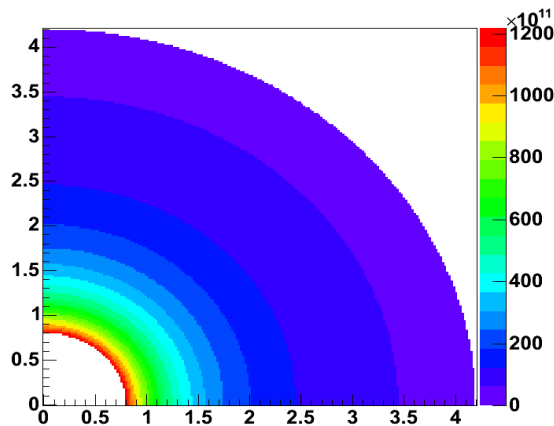


# LHCb VELO irradiation at 14 TeV



VELO operates in an harsh and non uniform radiation environment.

- At the nominal LHC energy VELO accumulates maximum of  $0.5 \times 10^{14} \text{ n}_{\text{eq}}/\text{cm}^2$ .
- The detector was designed to sustain 3 years of nominal data taking.
- Operational temperature : -8 - 0°C





# Radiation effects



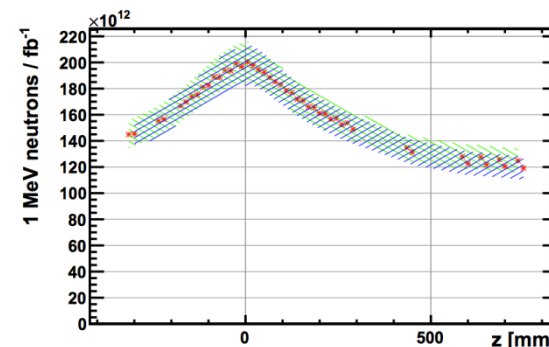
**BULK** damage due to generation of defects (additional generation and recombination centers) induces:

- ▶ Change of depletion voltage (cooling)
- ▶ Increase of **leakage current** (cooling) ✓
- ▶ Decrease of charge collection efficiency

**SURFACE** damage caused by scratches, surface currents in guard rings, edge effects,...

Leakage current in silicon evolution is a well predicted quantity – its change is a way to track the accumulate fluence.

The effects are counted for the integrated luminosity of  $1\text{fb}^{-1}$  and compared with the measured luminosity and temperature in LHCb.





# Leakage current measurement



$$\text{Current} = \text{Bulk current} + \text{Surface current}$$

## **BULK** current:

- ▶ increases with fluence
- ▶ exponential dependence on temperature
- ▶ saturates in HV ( $V_{\text{dep}}$ )

## **SURFACE:**

- ▶ decreases with fluence
- ▶ weak temperature dependence
- ▶ HV dependent

In order to follow radiation damage we need to disentangle both of them:

temperature scans (IT - current – temperature )  
current – voltage scans (IV )

LHCb-PUB-2011-020  
LHCb-PUB-2011-021  
Analysis of P.Collins  
and VELO group





# Monitoring radiation damage



Available data set:

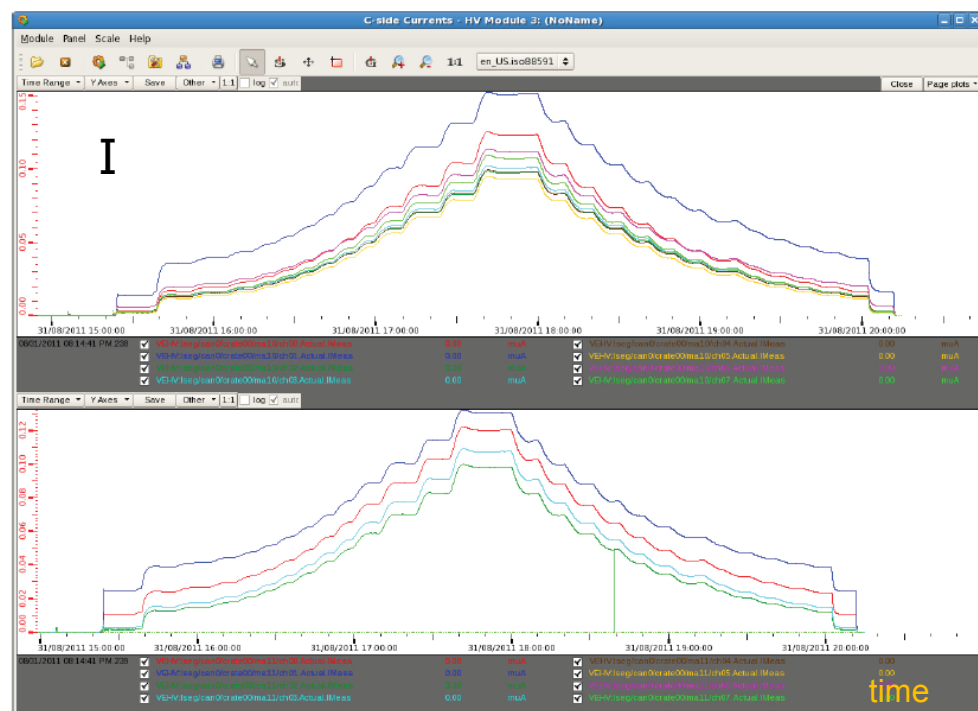
	HV	Lumi [ $\text{pb}^{-1}$ ]
IV scans (2009)	100 V	0
IT scans	100-150 V	480, 821, 1000
IV scans	0 -150- 0 V	weekly

## IV scans

taken weekly, no beam, results presented in the monitoring software (GUI),

## IT scans :

temperature ramped up & down in range between  $-30$  and  $5^{\circ}\text{C}$  with the step of  $2^{\circ}\text{C}$ ,  
HV constant 100 or 150V,  
work on generic analysis software (taken by Krakow group) in progress,

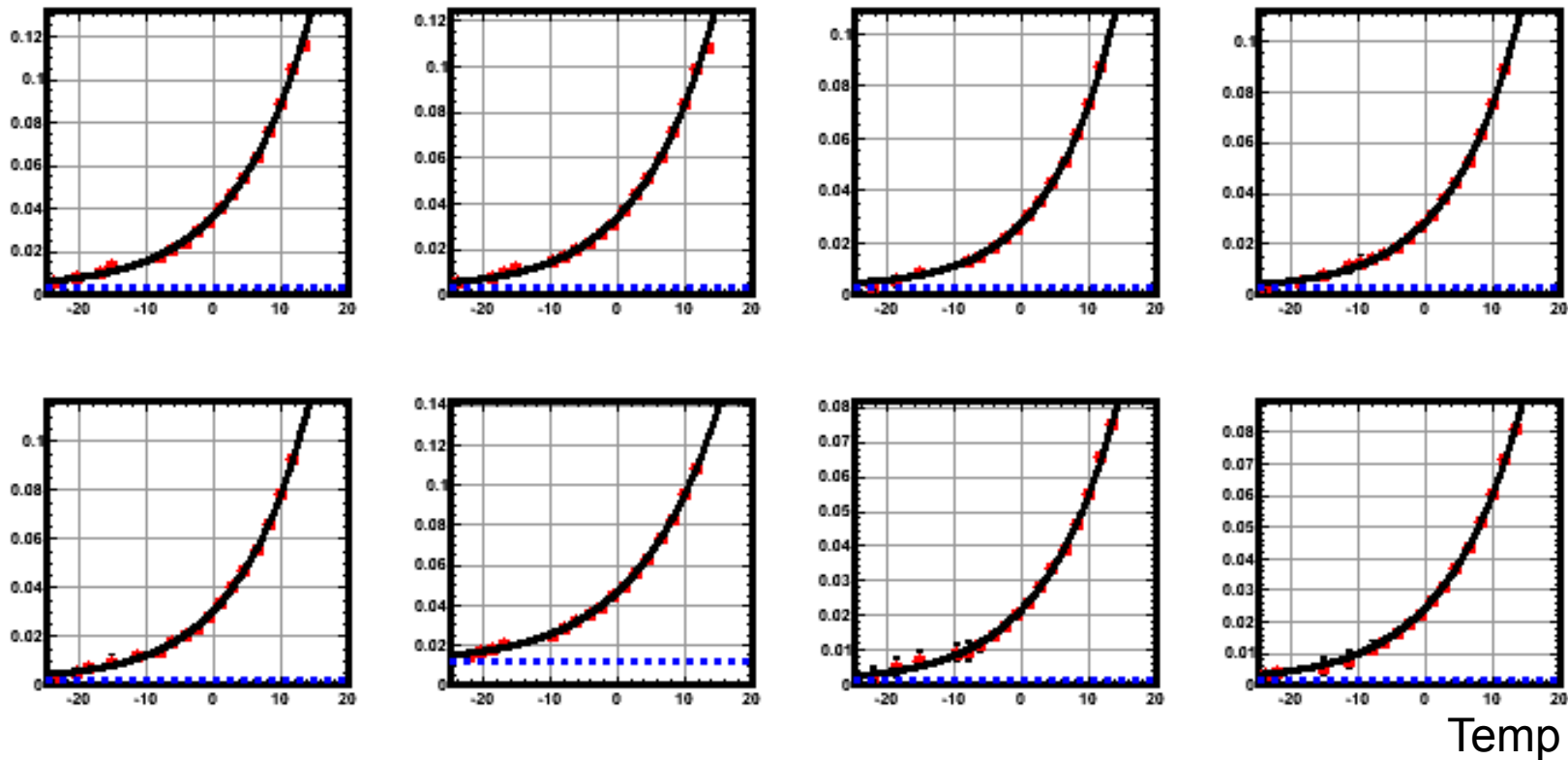


# Typical fits to the IT data

exponential formula (bulk contribution) + constant term (surface current)

$$I(T) \propto T^2 \exp\left(\frac{-E_g}{2kT}\right)$$

I

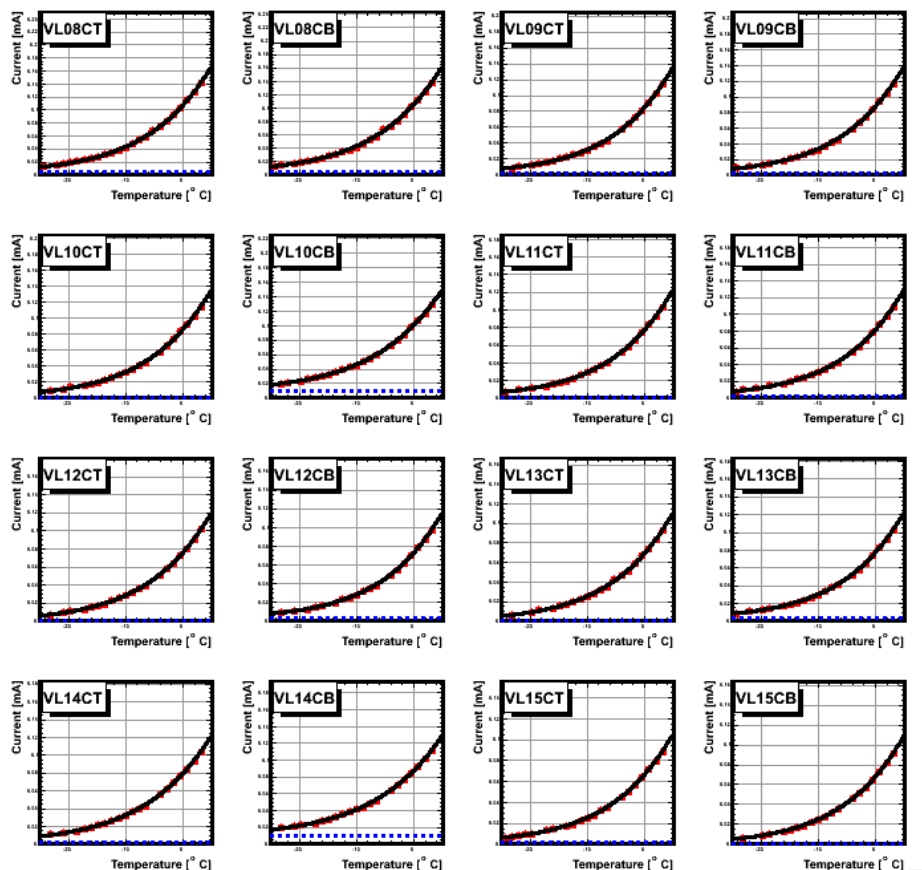




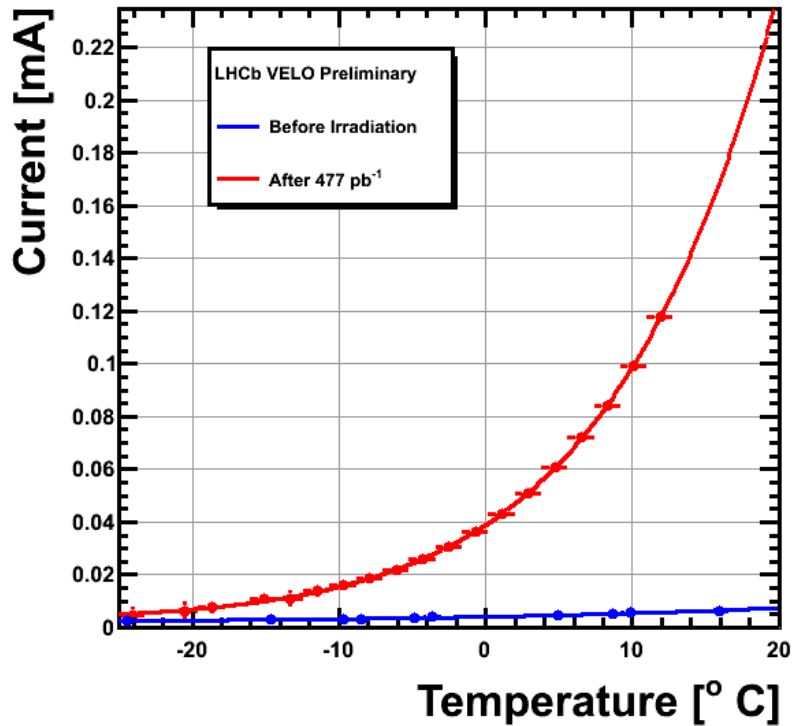
# The most recent IT scan



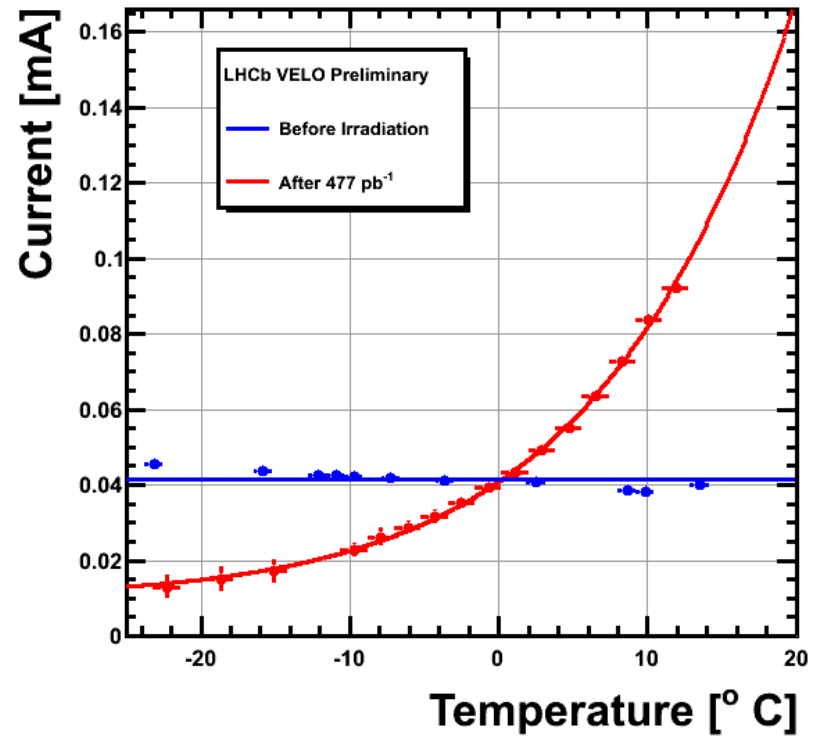
Lumi=1204 pb<sup>-1</sup>



# Bulk & surface currents



Bulk current dominated sensor



Surface current dominated sensor-annealing





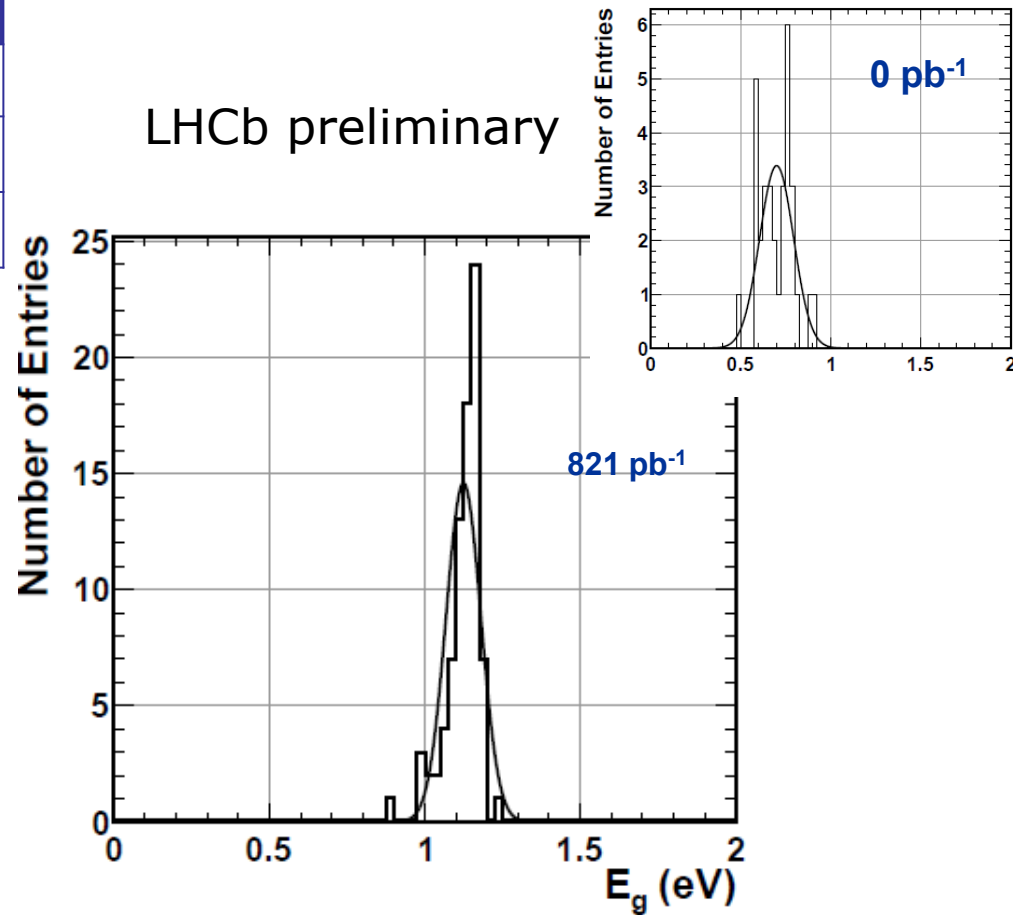
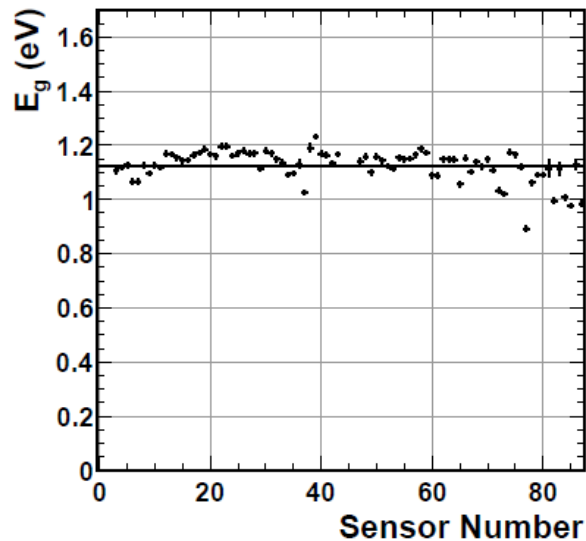
# Effective energy gap



The significant change in temperature for the fit allows to determine the  $E_g$

Data set	Lumi [pb <sup>-1</sup> ]	$E_g$ [eV]
IV scans	0	$0.69 \pm 0.08$
IT scan	821	$1.13 \pm 0.04$
IT scan	1204	$1.14 \pm 0.04$ eV

$E_g$  for each sensor:





## Change in bulk current

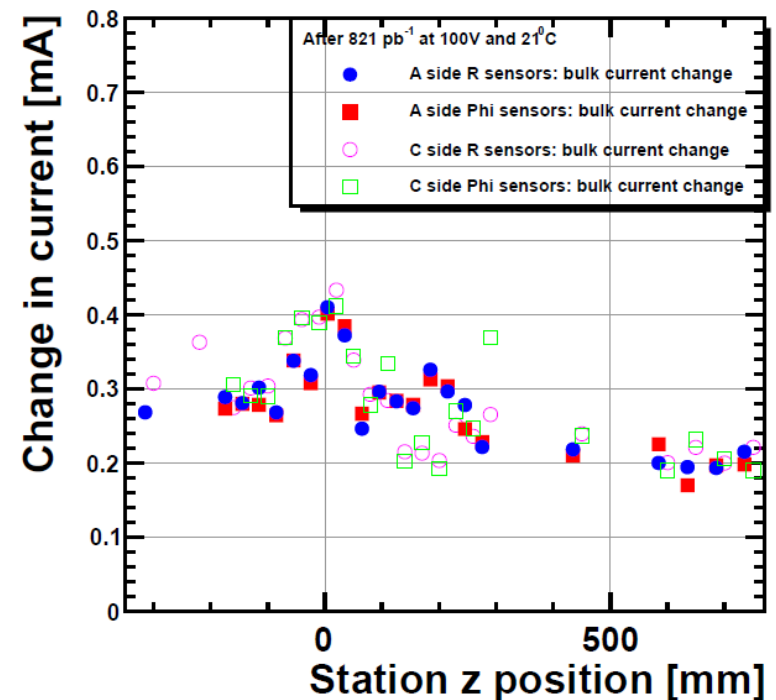


Currents are corrected to the same temperature (21°C and 0°C) for all sensors:

$$I(T_{ref}) = I(T) \left( \frac{T_{ref}}{T} \right)^2 \exp \left( -\frac{E_g}{2k} \left[ \frac{1}{T_{ref}} - \frac{1}{T} \right] \right)$$

T[°C]	Lumi [pb <sup>-1</sup> ]	ΔI
21	821	0.16÷0.44 mA
-8		9÷26 μA

ΔI dependence on z sensor position:

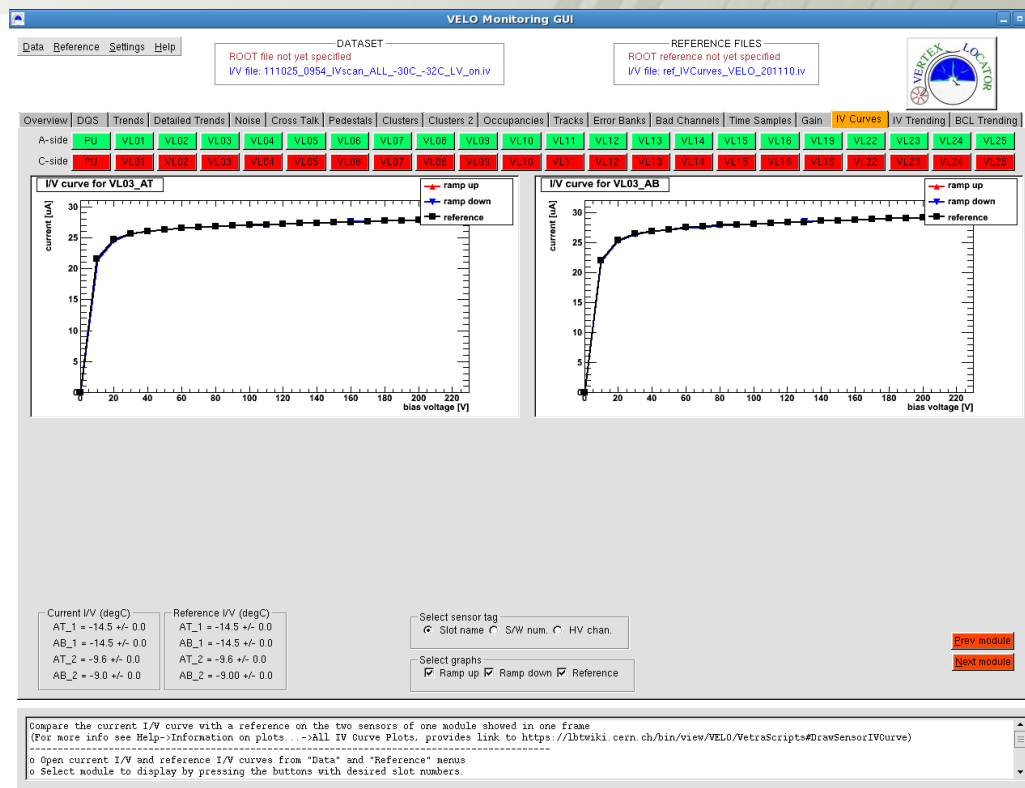




# IV scans



- ▶ Surface currents – ohmic behaviour.
- ▶ Bulk current – saturates with HV.
- ▶ **Current-voltage scans** are taken every week.
- ▶ Periodic voltage scans from 0 to 150V and back down.
- ▶ Each measurement recorded with NTC temperature value.
- ▶ Monitoring in GUI.

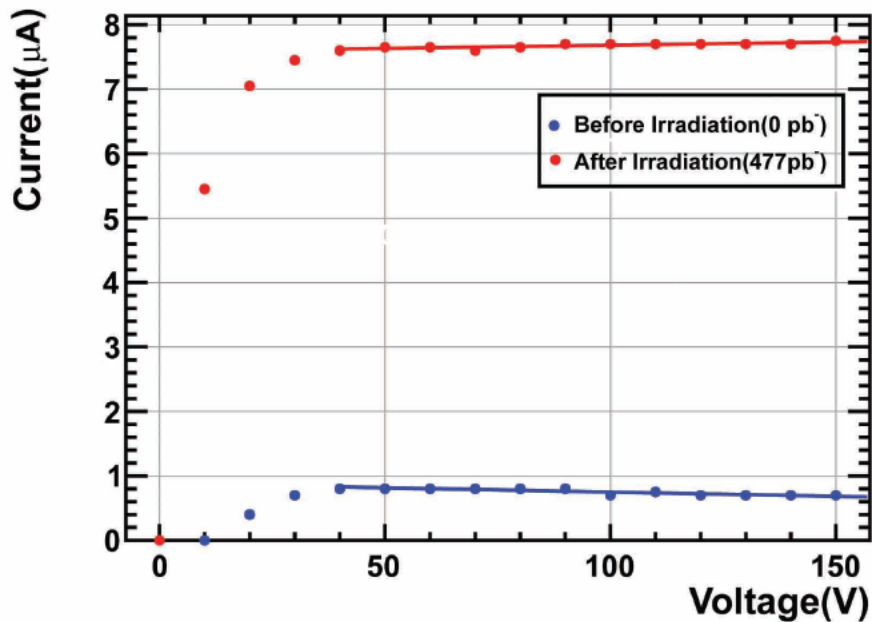




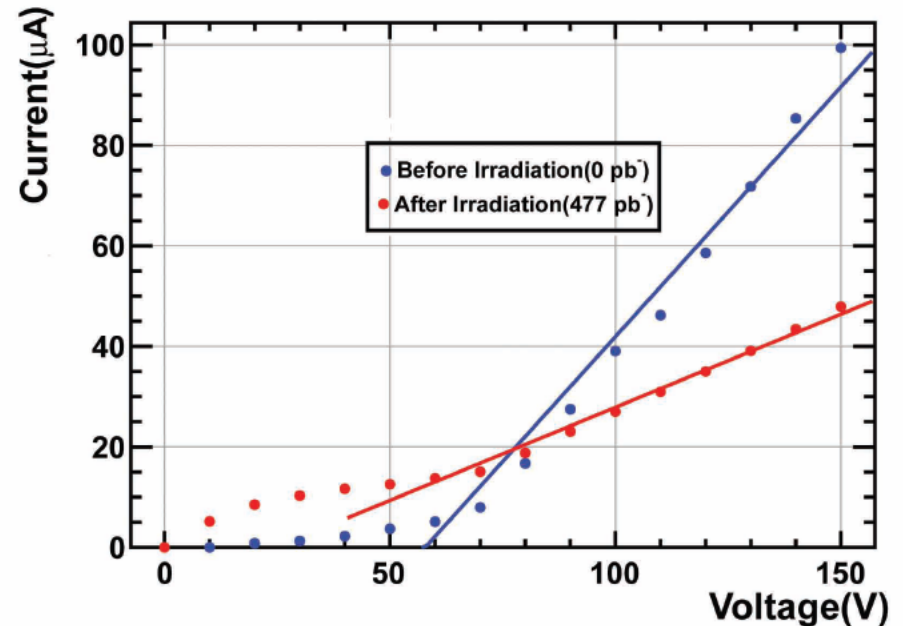
# Current-voltage fits



Two main types of current behavior:



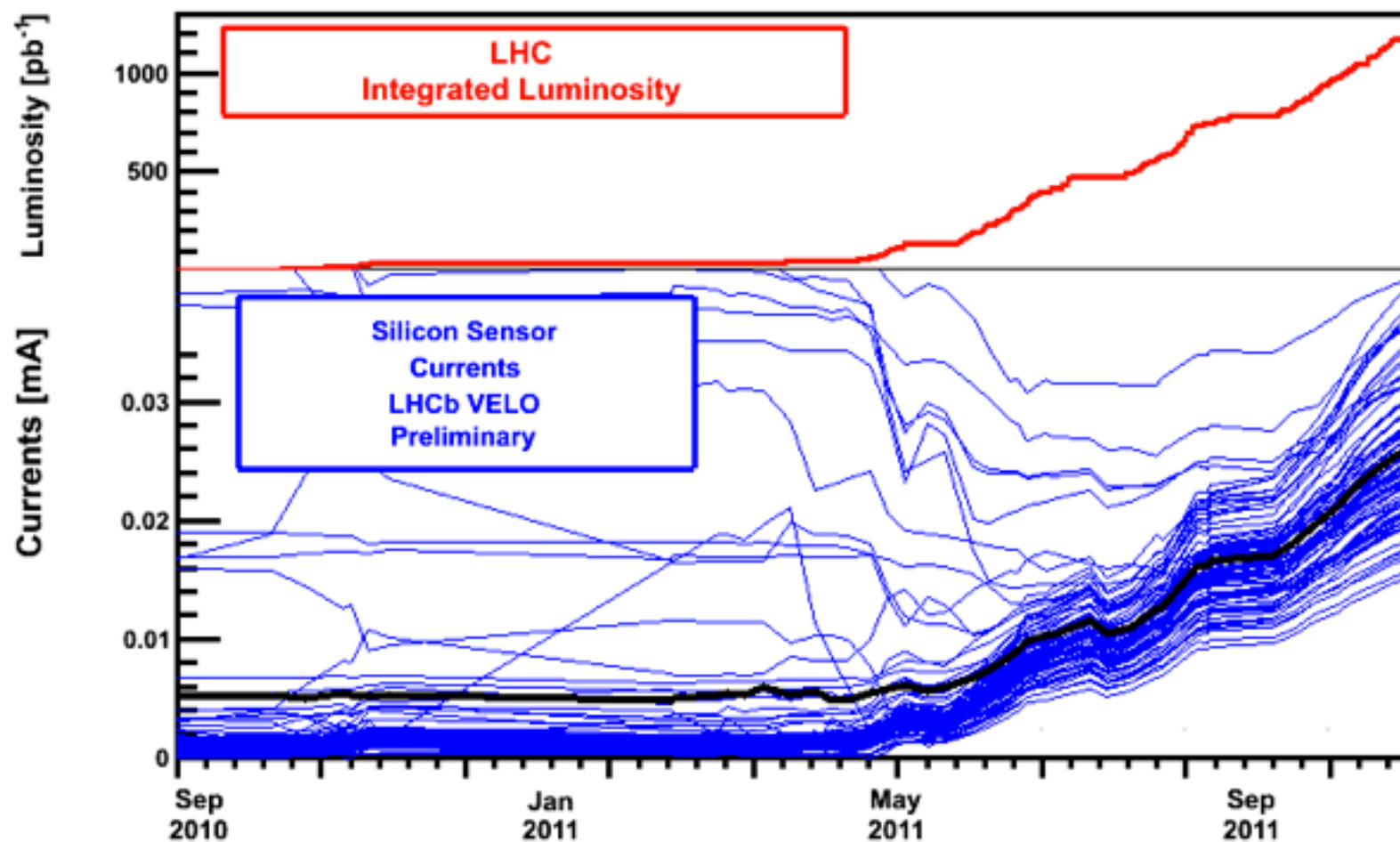
**Bulk current** dominated sensor  
before and after irradiation.  
Current increases and saturates (59  
sensors)



**Surface current** dominated sensor-  
ohmic component.  
Slopes decrease after irradiation (22  
sensors)



# Current vs Time



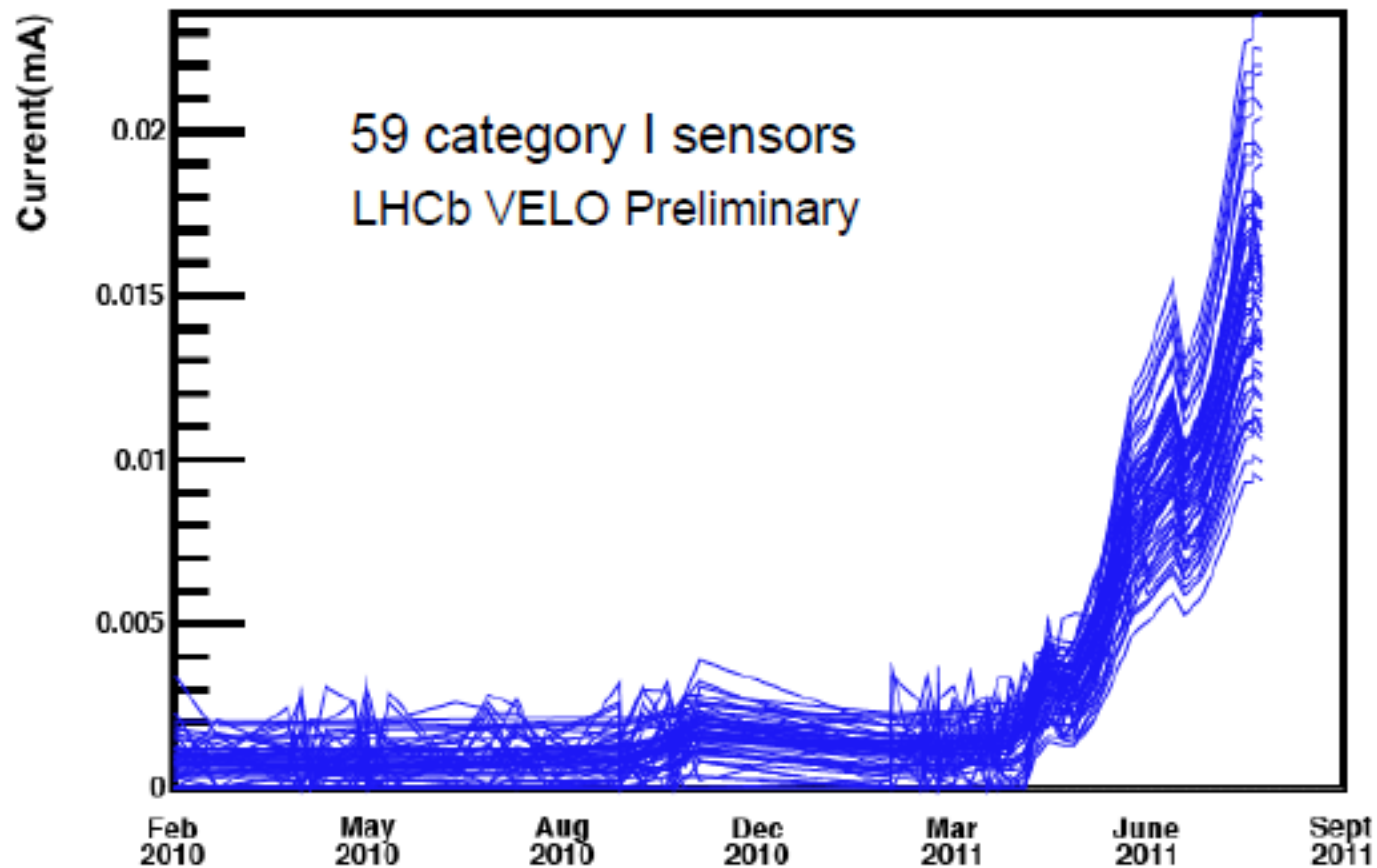




## Bulk current sensors



Simple requirements – slope is flat before and after irradiation:

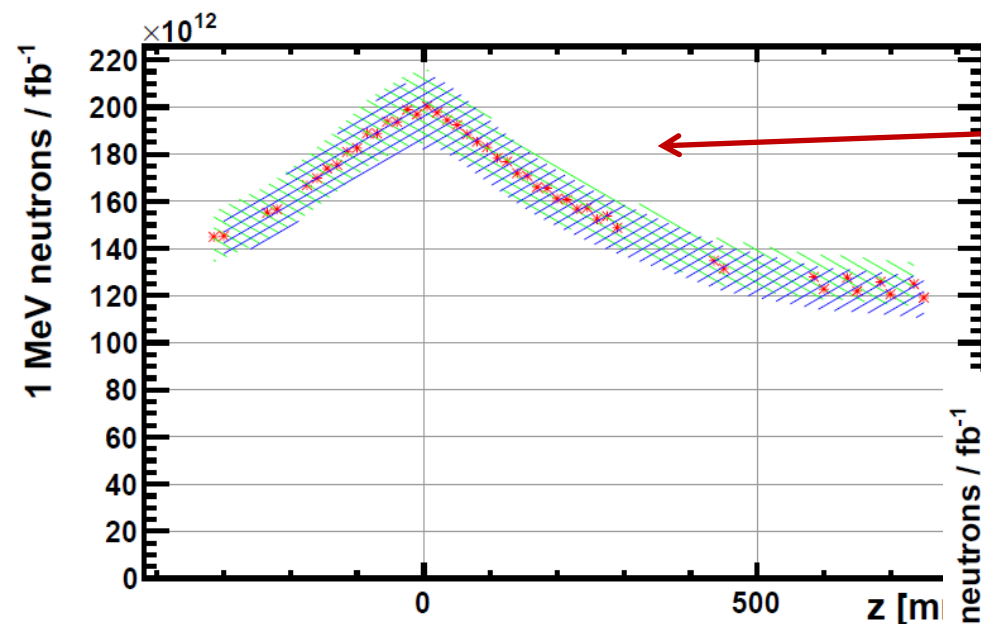




# Comparison with fluence prediction

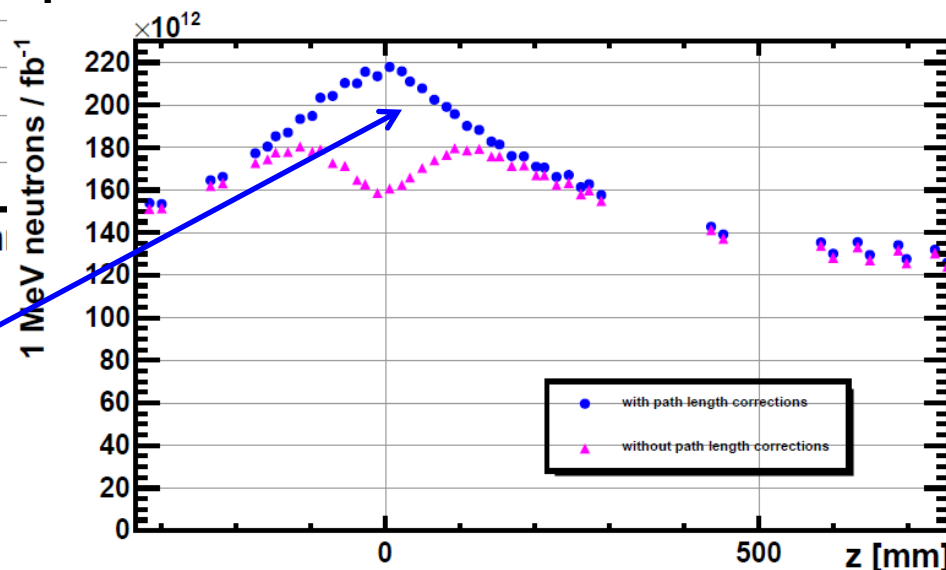


Simulated data – correction for path length in silicon



Prediction for the total fluence (beam of 3.5 GeV) for 1 fb<sup>-1</sup> as a function of a sensor's z – position

Most damage in sensors close to IP and large angles in silicon

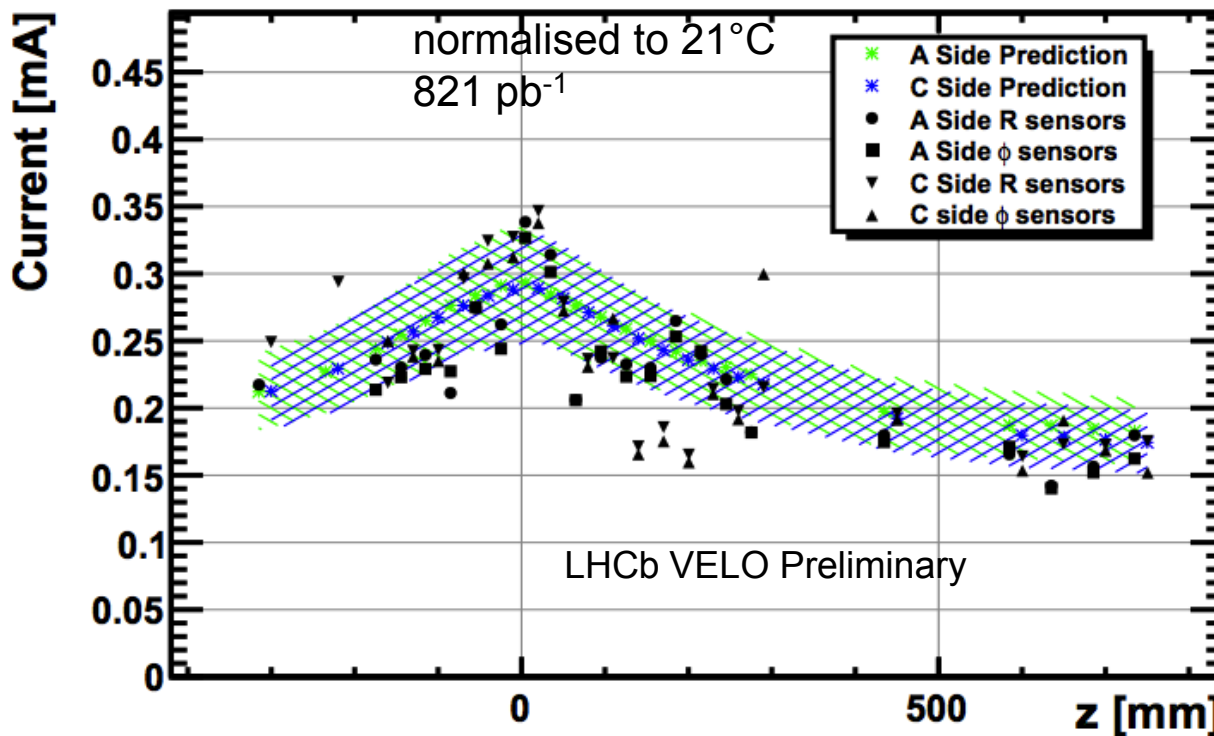




# Leakage currents prediction



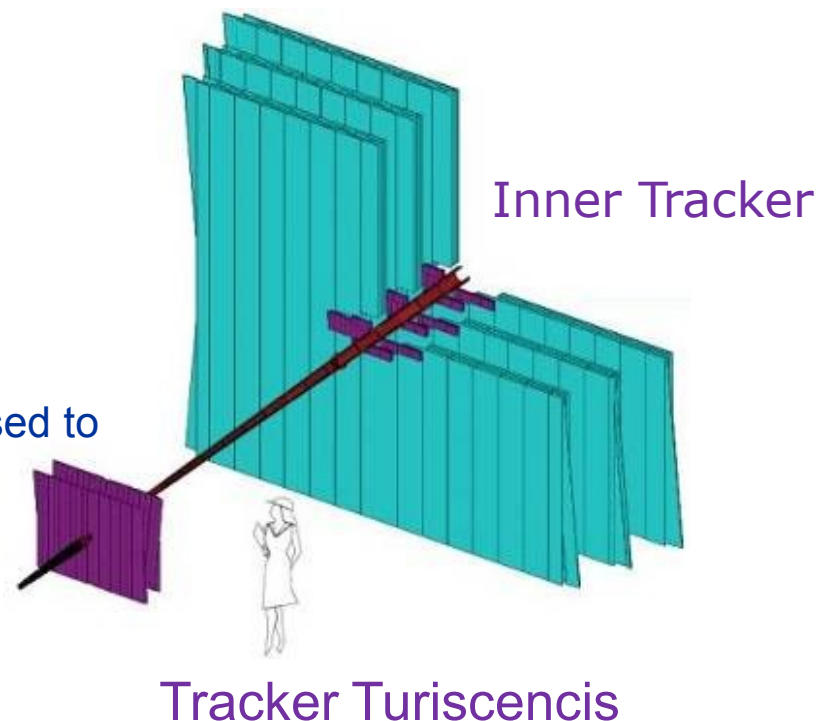
Leakage current increase is consistent with expectation and its change is caused mainly by charged particles directly produces in collisions.



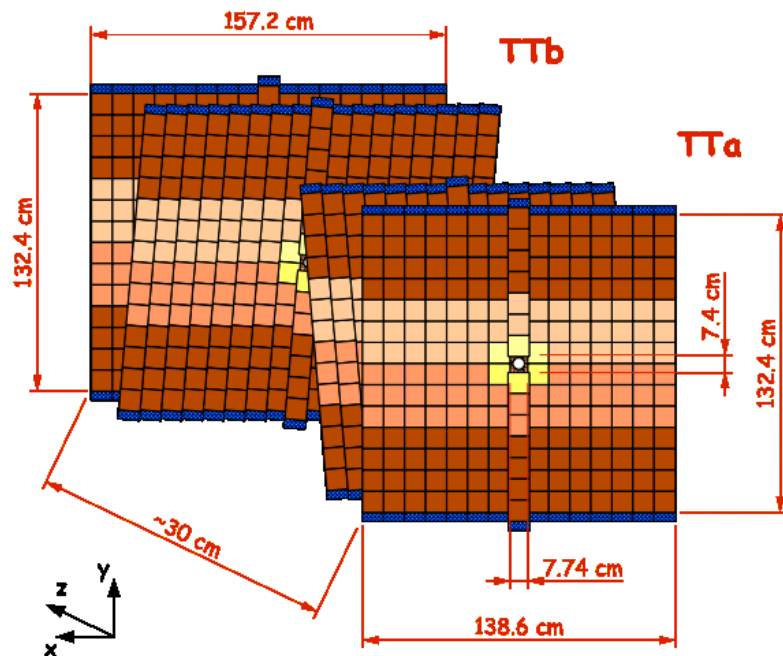
Good agreement – understanding of fluence modeling .

# Silicon Tracking system

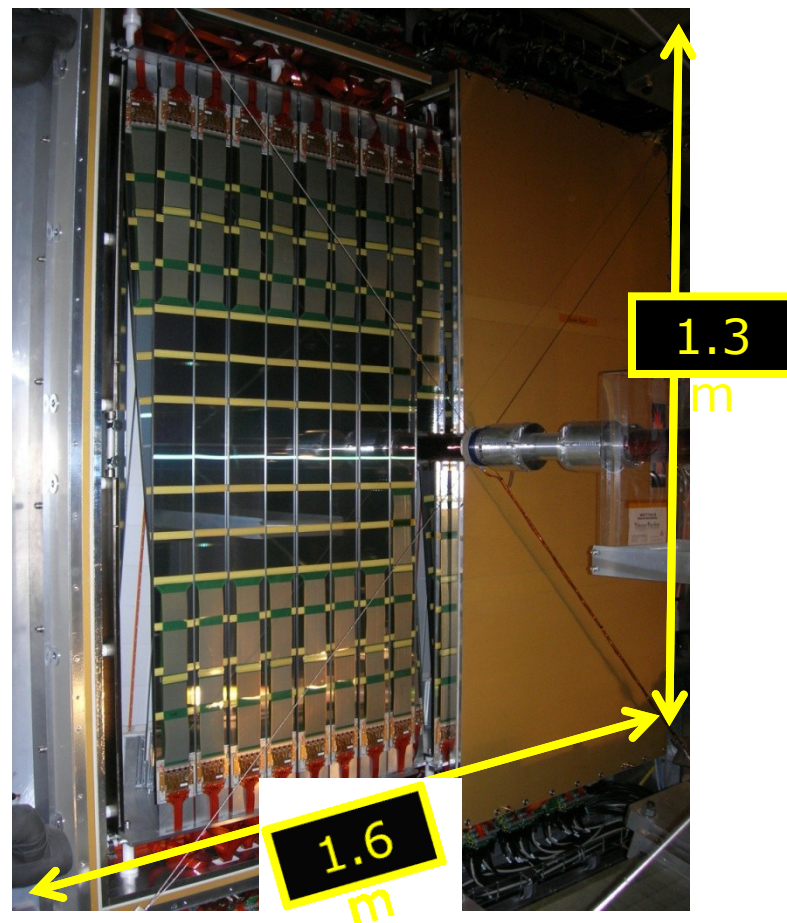
- ▶ **Silicon Tracker (ST)** comprises two detectors:
  - Tracer Turiscensis (Trigger Tracker)
  - Inner Tracker
- ▶ Four stations:
  - TT between VELO and magnet
  - 3 downstream tracking stations
- ▶ Hits combined with information from VELO used to reconstruct particle tracks – measure P
- ▶ Key properties:
  - p+-on-n
  - non-oxygenated
  - 500  $\mu\text{m}$  – TT
  - 320-410  $\mu\text{m}$  – IT
  - No second metal layer



# Tracker Turicensis

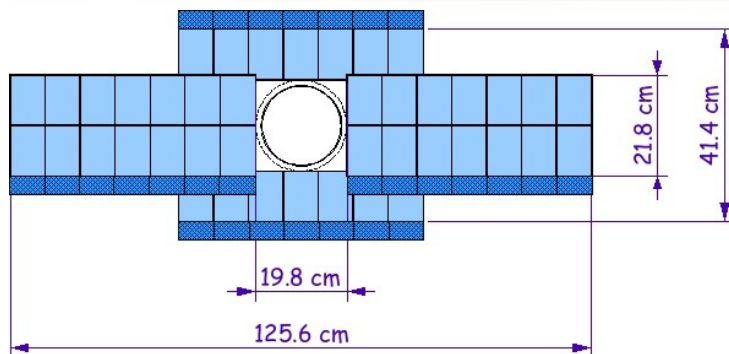


- ▶ S
- ▶ Four planes ( $0^\circ$ ,  $+5^\circ$ ,  $-5^\circ$ ,  $0^\circ$ ).
- ▶ Pitch:  $183\ \mu\text{m}$ ; Thickness:  $500\ \mu\text{m}$ .
- ▶ Long readout strips (up to 37 cm).
- 143360 readout channels.
- ▶ Total Silicon area is  $8\ \text{m}^2$ .  
Covers full acceptance before magnet.
- ▶ Cooling plant at  $0^\circ\text{C}$ : sensors  $\approx 8^\circ\text{C}$ .

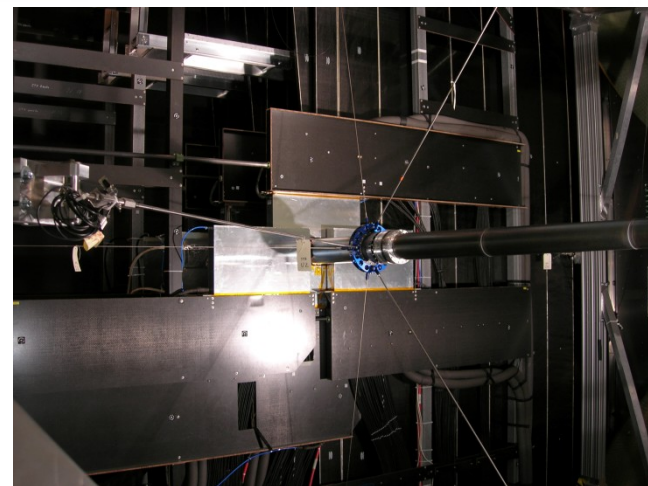




# Inner tracker



- ▶ Silicon micro-strip detectors (p-in-n).
- ▶ Three stations in z.
  - Four boxes in each station.
  - Four planes ( $0^\circ$ ,  $+5^\circ$ ,  $-5^\circ$ ,  $0^\circ$ )
  - Pitch:  $198 \mu\text{m}$
  - Thickness:  $320$  or  $410 \mu\text{m}$
  - 129024 readout channels.
- ▶ Total Silicon area is  $4.2 \text{ m}^2$ .
  - Covers region around beam with highest flux.
- ▶ Cooling plant at  $0^\circ\text{C}$ : sensors  $\approx 10^\circ\text{C}$ .

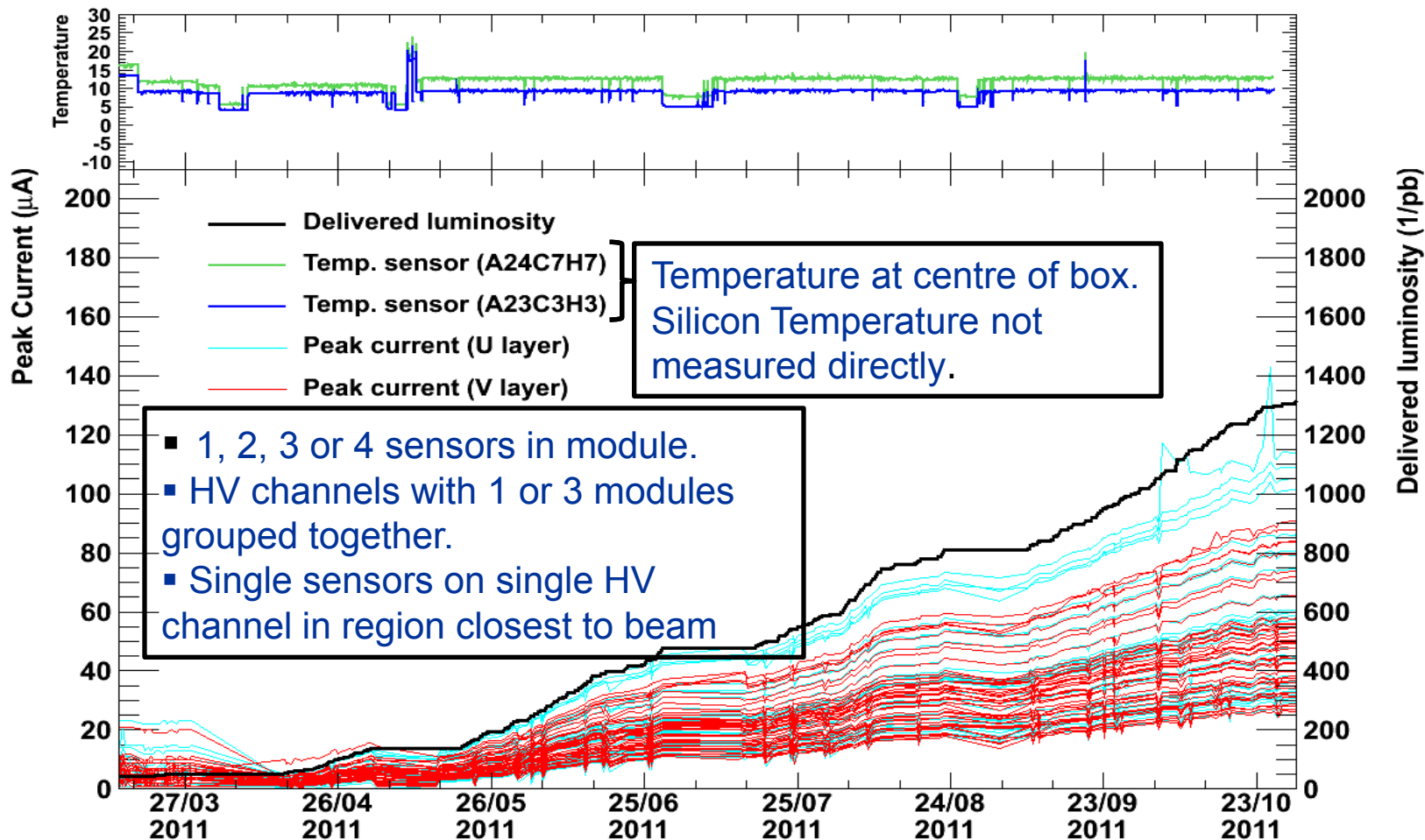


# Monitoring radiation damage in the ST



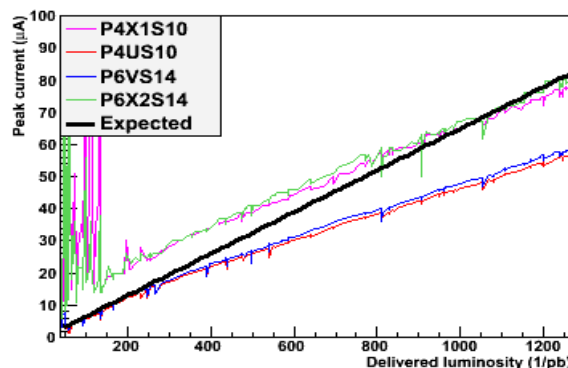
- ▶ Expected Radiation Dose (10 years):
  - IT:  $5 \times 10^{13}$  1-MeV neutron equivalent.
  - TT:  $8 \times 10^{13}$  1-MeV neutron equivalent.
- ▶ Monitor change in leakage currents.
  - Plot the peak current in a fill vs time.
  - Expected changed calculated using (old) FLUKA simulation.
  - IT:  $\Delta I(10^\circ\text{C}) = 0.103 (0.031) \mu\text{A}/\text{pb}^{-1}$ .
  - TT:  $\Delta I(8^\circ\text{C}) = 0.065 \mu\text{A}/\text{pb}^{-1}$ .
- ▶ Monitor changes in depletion voltage
  - Charge Collection Efficiency.
- ▶ Expect type inversion after 1-2 years.

# Current evolution in TT

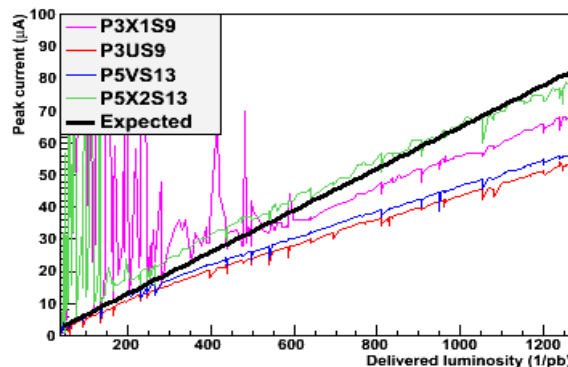
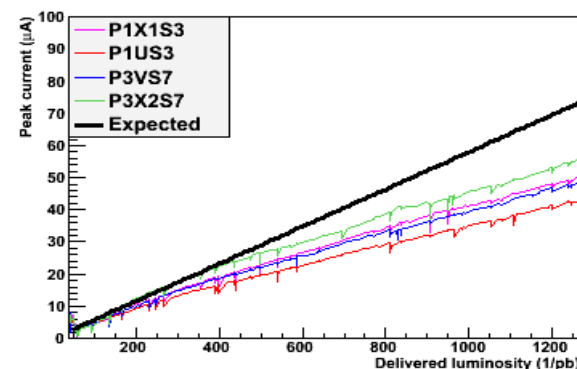
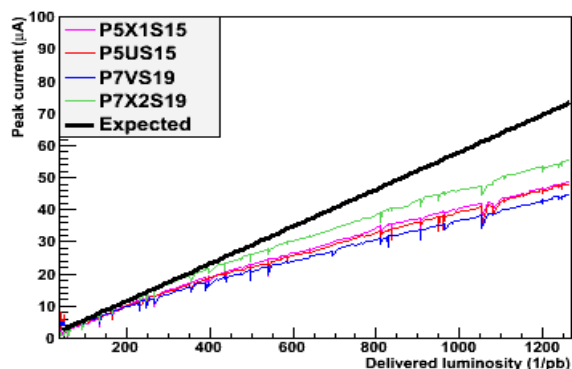
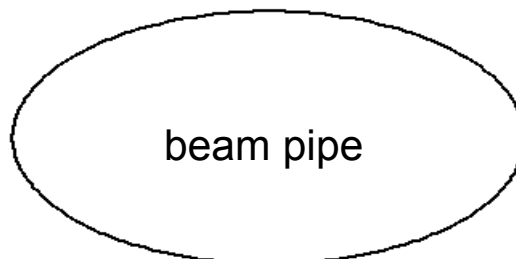
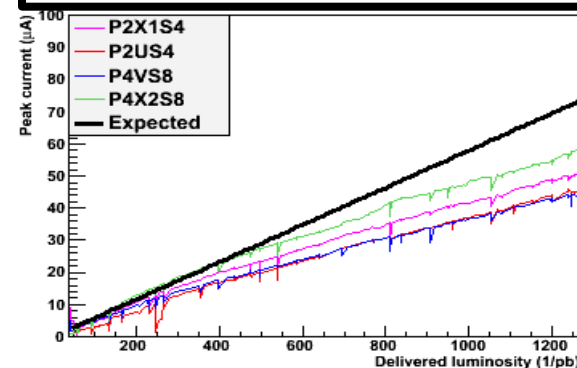
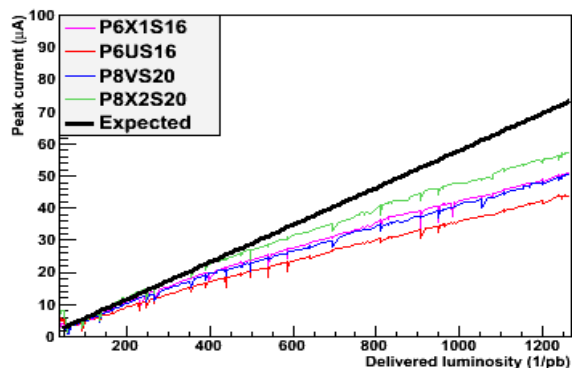


# Leakage current evolution in TT

- Sensors closest to the beam.
- Colour indicates layer.



- Results within expectations.
- Need to include annealing in predictions.



# Current evolution in IT

As for TT, HV is grouped together.

Short

Current [ $\mu\text{A}$ ]

100  
90  
80  
70  
60  
50  
40  
30  
20  
10  
0

0 100 200 300 400 500 600 700 800 900

Delivered Luminosity [ $\text{pb}^{-1}$ ]

Long

Current [ $\mu\text{A}$ ]

100  
90  
80  
70  
60  
50  
40  
30  
20  
10  
0

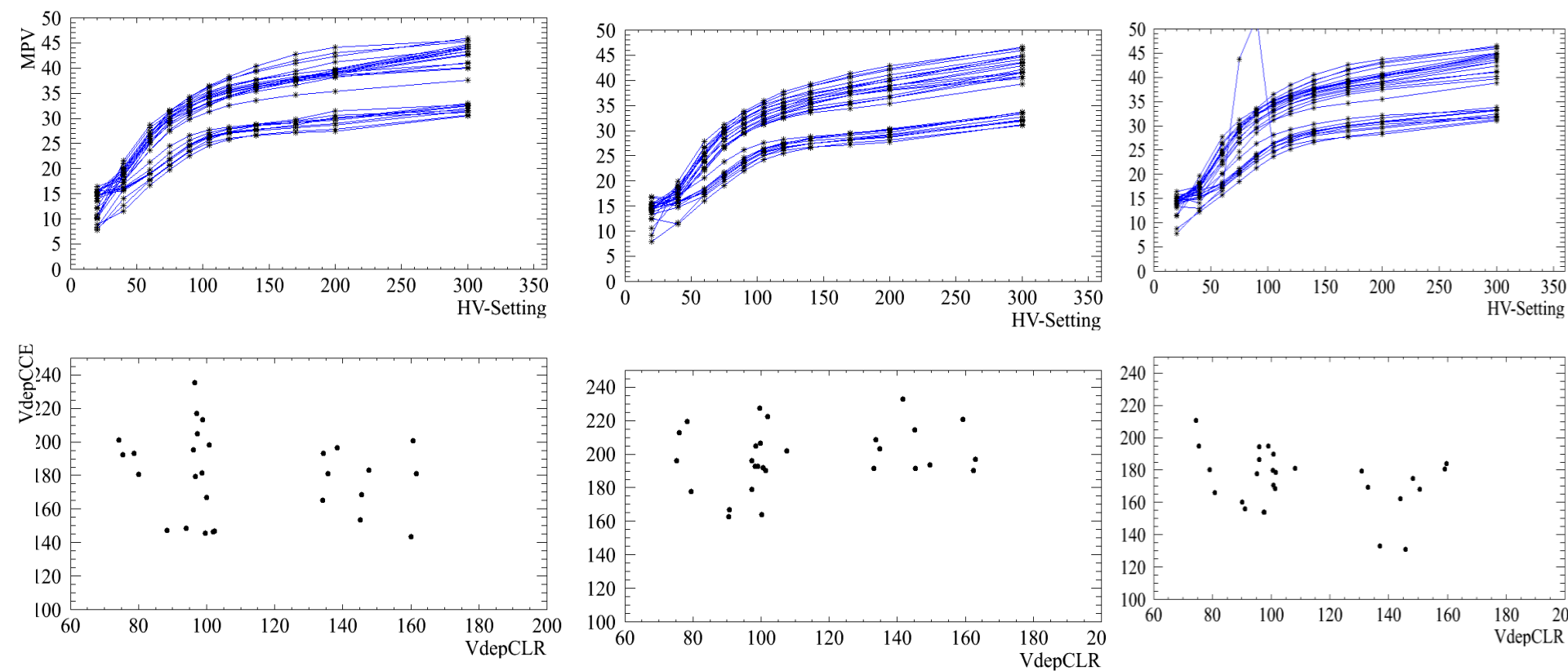
0 100 200 300 400 500 600 700 800 900

Delivered Luminosity [ $\text{pb}^{-1}$ ]



# IT HV-vs-Depletion Voltage

plot  $V_{\text{dep}}$  from CCE-scan versus  $V_{\text{de}}$  from capacitance measurement during production



Analysis still on-going: results here are extremely preliminary



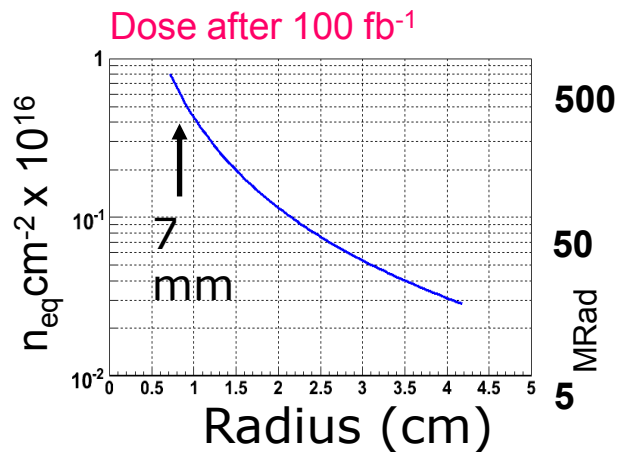
## Final remarks



- ▶ Two monitoring methods: IV and IT scans provide information on bulk/surface component of leakage current.
- ▶ Temperature scans are more accurate and allow to measure  $E_g$ .
- ▶ VELO data used for measuring fluence and ageing.

What will happen next?

Before the scheduled upgrade (2018-19) VELO will collect  $\sim 9 \text{ fb}^{-1}$ .  
At 7 mm from beam sensor accumulate  $8 \times 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$  for  $100 \text{ fb}^{-1}$ .



In the absence of accidents and assuming the upgrade keeps to schedule, we would expect not to insert the replacement but change from the current VELO to the upgrade.